

HLN Technologies Limited
Registration No. 200402180C

Use of Share Placement Proceeds

The Board of Directors of HLN Technologies Limited (the 'Company') refers to the placement of 21,000,000 ordinary shares in the capital of the Company which was completed on 8 September 2008 and wishes to update the use of the placement proceeds as at 15 November 2009.

Amount of placement proceeds raised

	<u>S\$'000</u>
Amount raised	3,129
Less: Placement expenses	<u>(189)</u>
Net placement proceeds	<u>2,940</u>

The actual placement expenses were S\$189,000 compared to the estimated S\$199,000 in the OIS dated 27 August 2008. Hence, approximately S\$10,000 is transferred to working capital purpose of the Group and net placement proceeds increased from S\$2,930,000 to S\$2,940,000.

Use of placement proceeds as at 15 November 2009 is as follows:-

S/N	Intended Use	Amount allocated (S\$'000)	Amount utilized (S\$'000)	Balance amount (S\$'000)
1	To expand the Group's polymeric facility in Suzhou	1,150	1,150	0
2	To repay loans to financial institutions	967	967	0
3	As working capital for the Group	823	823	0
	Total	2,940	2,940	0

The Company has fully utilized the placement proceeds.

By order of the Board

Cheong Wei Xiong
Chief Executive Officer
17 November 2009